Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
	IDC Wah Site for Information on IDC 1752 Standard Form Type				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia				ials and Mfg Information			
Supplier Information												
Company name* Company unique ID				Unique ID Authority				Res	Response Date*			
onsemi	nsemi				2024-04-18							
ontact Name Title - Contact				P	Phone - Contact*				Email - Contact*			
Product-Env-Stewards Product Enviro Compliance				NA				Pro	Product-Env-Stewards@onsemi.com			
uthorized Representative* Title - Representative				Phone - Representative*				Ema	Email - Representative*			
Product-Env-Stewards	Product Envi	Product Enviro Compliance			NA			Pro	Product-Env-Stewards@onsemi.com			
Requester Item Number Mfr	tem Number	Number Mfr Item Name			Effective Date	Version Manufacturing Site		Site	Weight*	UOM	Unit Type	
ARO AO-C	234CSSC28SUK P1				2024-04-18		TWU	TWU		mg	Each	
Manufacturing Process Information									į			
Terminal Plating / Grid Array Material	Terminal Base	Cerminal Base Alloy J-STD-02			Peak Process Body Temperature Max Time at Pe		at Peak Temp	perature Number	er of Reflow Cyc	eles		
SnAgCu	nAgCu CU Alloy 4				245	C	30	S	econds 3			
Comments												
or more information regarding material composit	on please refer to	nage 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	ed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.									
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted				
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the				

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	19.54	mg	Supplier	Silicon (Si)	7440-21-3		19.54	mg
Glass Attach Epoxy	0.0012	mg	Supplier	Imidazole	288-32-4		0.0003	mg
			Supplier	Epoxy Phenol Novolak Resin	28064-14-4		0.0009	mg
Glass Lid /Cap	54.35	mg	Supplier	Glass	65977-17-3		54.35	mg
Insulating Layer	5.51	mg	Supplier	9-Phenylacridine	602-56-2		0.2755	mg
			Supplier	2-Propenoic acid	1245638-61-2		1.653	mg
			Supplier	Other Additive Agents	Proprietary Data		3.306	mg
			Supplier	Butylglycol Acetate	112-07-2		0.2755	mg
Passivation	1.22	mg		Epoxy resin	proprietary data		0.0183	mg
			Supplier	Coupling Agent	Proprietary Data		0.0244	mg
			Supplier	Modified SBR Rubber	Proprietary Data		0.0061	mg
			Supplier	Melamine Compound	Proprietary Data		0.0366	mg
			Supplier	Trispenol Compound	Proprietary Data		0.0366	mg
			Supplier	Photosensitizer	Proprietary Data		0.0976	mg
			Supplier	Hydroxystyrene Resin	Proprietary Data		0.2684	mg
			Supplier	Ethyl Lactate	97-64-3		0.732	mg
RDL	0.82	mg	В	Nickel (Ni)	7440-02-0		0.492	mg
			Supplier	Gold (Au)	7440-57-5		0.0082	mg
			Supplier	Copper (Cu)	7440-50-8		0.3198	mg
Solder Ball	0.92	mg	Supplier	Silver (Ag)	7440-22-4		0.0611	mg
			Supplier	Tin (Sn)	7440-31-5		0.8181	mg
			Supplier	Copper (Cu)	7440-50-8		0.0408	mg